

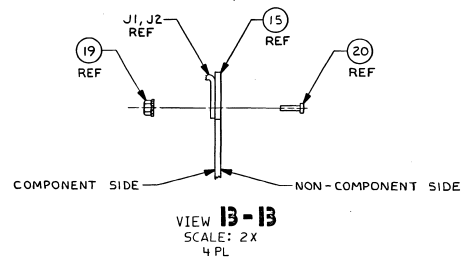
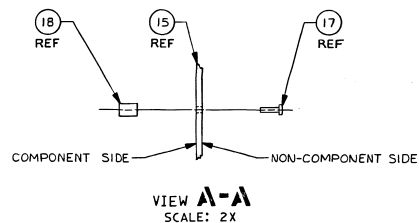
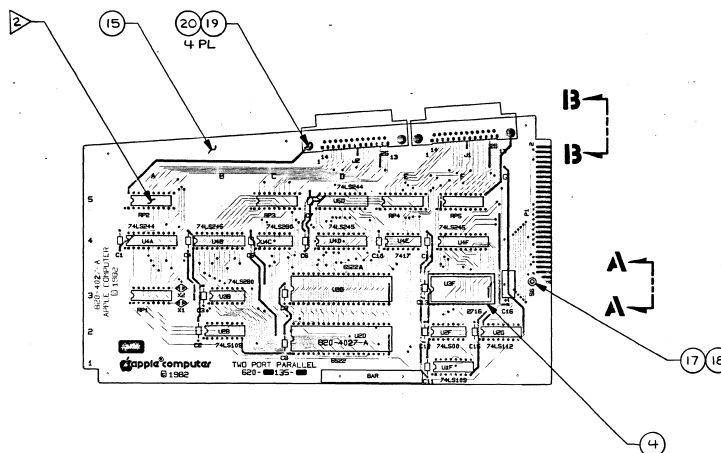
**NOTE: UNLESS OTHERWISE SPECIFIED**

1. THE ASSY KEY LEVEL MUST CORRESPOND WITH THE BILL OF MATERIAL KEY LEVEL. MANUFACTURING MUST STAMP THE LATEST KEY LEVEL IN THE APPROPRIATE LOCATION ON THE PCB AFTER ASSEMBLY OR REMOVAL.

THE 16 PIN R PACKS R22-R25 TO BE CENTERED ON 20 PIN PAD LAYOUT. REMAINING 4 HOLES CAN FILL WITH SOLDER.

3. PCB ASSY MUST CONFORM TO APPLE WORKMANSHIP STD 060-0012.

REV	DATE	ECO	REVISION	VPD
A	8/78		INITIAL RELEASE	
B	3C	B250	ITEM 20, 4PL WAS ITEM 17, 4PL	15



REFERENCE DOCUMENTATION:  
BILL OF MATERIAL 620-0135  
SCHEMATIC 050-4027

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ITEM	QTY	PART NUMBER	DESCRIPTION
1	1	620-0135-B	ASSEMBLY, PCB PARALLEL I/F LISA
2	1	620-0135-B	ASSEMBLY, PCB PARALLEL I/F LISA



THIRD ANGLE PROJECTION  
FOR SIZE SCALE DRAWING

DATE: 8/78  
BY: J. J. J.

SCALE: FULL

SHEET: 1 OF 1

FIGURE: FULL

FIGURE: FULL

FIGURE: FULL

FIGURE: FULL

FIGURE: FULL

FIGURE: FULL

FIGURE: FULL

FIGURE: FULL

FIGURE: FULL

FIGURE: FULL

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